

# TPS54140EVM-429 1.5-A, SWIFT™ Regulator Evaluation Module

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_	TDCF 44 40CVM 400 Bill of Motoriolo



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#### 1 Introduction

This user's guide contains background information for the TPS54140 as well as support documentation for the TPS54140EVM-429 evaluation module (HPA429). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54140EVM-429.

## 1.1 Background

The TPS54140 dc/dc converter is designed to provide up to a 1.5 A output from an input voltage source of 3.5 V to 42 V. Rated input voltage and output current range for the evaluation module are given in Table 1. This evaluation module is designed to demonstrate the small printed-circuit-board areas that may be achieved when designing with the TPS54140 regulator. The switching frequency is externally set at a nominal 500 kHz. The high-side MOSFET is incorporated inside the TPS54140 package along with the gate drive circuitry. The low drain-to-source on resistance of the MOSFET allows the TPS54140 to achieve high efficiencies and helps keep the junction temperature low at high output currents. The compensation components are external to the integrated circuit (IC), and an external divider allows for an adjustable output voltage. Additionally, the TPS54140 provides adjustable slow start and undervoltage lockout inputs. The absolute maximum input voltage is 42 V for the TPS54140EVM-429.

**Table 1. Input Voltage and Output Current Summary** 

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE		
TPS54140EVM-429	VIN = 25 V to 42 V	0 A to 1.5A		

# 1.2 Performance Specification Summary

A summary of the TPS54140EVM-429 performance specifications is provided in Table 2. Specifications are given for an input voltage of  $V_{IN}$  = 34 V and an output voltage of 3.3 V, unless otherwise specified. The TPS54140EVM-429 is designed and tested for  $V_{IN}$  = 25 V to 42 V. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. TPS54140EVM-429 Performance Specification Summary

SPECIFICATION	TEST CO	ONDITIONS	MIN	TYP	MAX	UNIT
V <sub>IN</sub> voltage range			25	34	42	V
Output voltage set point				3.3		V
Output current range	V <sub>IN</sub> = 25 V to 42 V	V <sub>IN</sub> = 25 V to 42 V			1.5	Α
Line regulation	$I_{O} = 0.75 \text{ A}, V_{IN} = 25 \text{ V t}$	o 42 V	=	±0.025%		
Load regulation	V <sub>IN</sub> = 34 V, I <sub>O</sub> = 0 A to 1.5 A		±0.05%			
	I <sub>O</sub> = 0.25 A to 1.25 A	Voltage change		-55		mV
		Recovery time		1		ms
Load transient response	I <sub>O</sub> = 1.25 A to 0.25 A	Voltage change		60		mV
		Recovery time		1		ms
Loop bandwidth	V <sub>IN</sub> = 34 V, I <sub>O</sub> = 1.5 A			21		kHz
Phase margin $V_{IN} = 34 \text{ V}$ , $I_{O} = 1.5 \text{ A}$			62		0	
Input ripple voltage	nput ripple voltage $I_O = 1.5 \text{ A}$			160		$mV_{PP}$
Output ripple voltage $I_O = 1.5A$				5		$mV_{PP}$
Output rise time				4		ms
Operating frequency				500		kHz
Maximum efficiency TPS54140EVM-429, $V_{IN} = 25 \text{ V}$ , $I_O = 0.6 \text{ A}$			86%			

3



#### 1.3 Modifications

These evaluation modules are designed to provide access to the features of the TPS54140. Some modifications can be made to this module.

#### 1.3.1 Output Voltage Set Point

To change the output voltage of the EVM, it is necessary to change the value of resistor  $R_6$ . Changing the value of  $R_6$  can change the output voltage above 0.8 V. The value of  $R_6$  for a specific output voltage can be calculated using Equation 1.

$$R_6 = 10 \text{ k}\Omega \times \frac{(V_{OUT} - 0.8 \text{ V})}{0.8 \text{ V}}$$
 (1)

Table 3 lists the  $R_6$  values for some common output voltages. Note that  $V_{IN}$  must be in a range so that the minimum on-time is greater than 130 ns, and the maximum duty cycle is less than 91%. The values given in Table 3 are standard values, not the exact value calculated using Equation 1.

 Output Voltage (V)
 R<sub>6</sub> Value (kΩ)

 1.8
 12.4

 2.5
 21.5

 3.3
 31.6

 5
 52.3

**Table 3. Output Voltages Available** 

Be aware that changing the output voltage can affect the loop response. It may be necessary to modify the compensation components. See the datasheet for details.

# 2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS54140EVM-429 evaluation module. The section also includes test results typical for the evaluation module and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and start-up.

## 2.1 Input / Output Connections

The TPS54140EVM-429 is provided with input/output connectors and test points as shown in Table 4. A power supply capable of supplying 1A must be connected to J1 through a pair of 20 AWG wires. The load must be connected to J4 through a pair of 20 AWG wires. The maximum load current capability must be 1.5 A. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the  $V_{IN}$  input voltages with TP2 providing a convenient ground reference. TP9 is used to monitor the output voltage with TP10 as the ground reference.



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**Table 4. EVM Connectors and Test Points** 

Reference Designator	Function		
J1	V <sub>IN</sub> (see Table 1 for V <sub>IN</sub> range)		
J2 V <sub>OUT</sub> , 3.3 V at 0.5 A maximum			
TP1	V <sub>IN</sub> test point at V <sub>IN</sub> connector		
TP2	GND test point at V <sub>IN</sub>		
TP3	EN test point. Connect EN to ground to disable, open to enable.		
TP4 Slow start monitor test point			
TP5	PWRGD test point		
TP6	PH test point		
TP7	Output voltage test point at voltage divider. Used for loop response measurements.		
TP8 Test point between voltage divider network and output. Used for loop response measurements.			
TP9 Output voltage test point at OUT connector			
TP10	GND test point at OUT connector		

# 2.2 Efficiency

The efficiency of this EVM peaks at a load current of about 0.5 A - 1 A and then decreases as the load current increases towards full load. Figure 1 shows the efficiency for the TPS54140EVM-429 at an ambient temperature of 25°C.

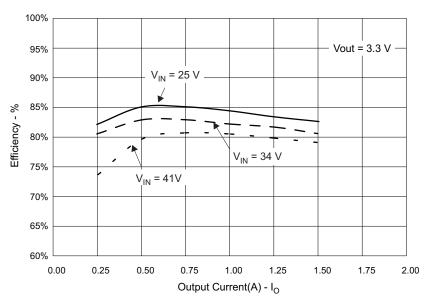


Figure 1. TPS54140EVM-429 Efficiency

Figure 2 shows the efficiency for the TPS54140EVM-429 at lower output currents between 0.02 A and 0.25 A at an ambient temperature of 25°C.

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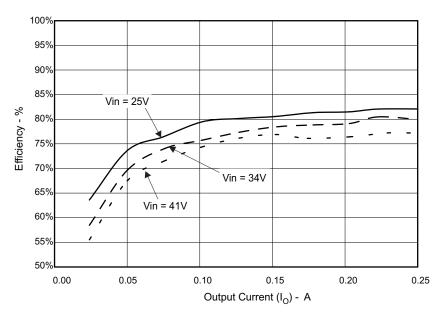


Figure 2. TPS54140EVM-429 Low Current Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

# 2.3 Output Voltage Load Regulation

The load regulation for the TPS54140EVM-429 is shown in Figure 3.

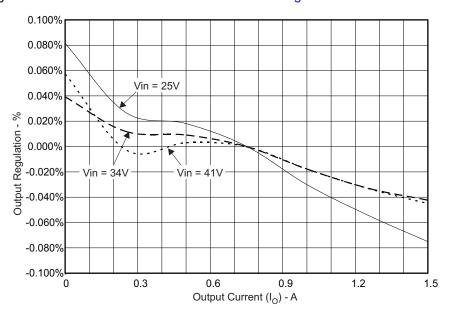


Figure 3. TPS54140EVM-429 Load Regulation

Measurements are given for an ambient temperature of 25°C.

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# 2.4 Output Voltage Line Regulation

The line regulation for the TPS54140EVM-429 is shown in Figure 4.

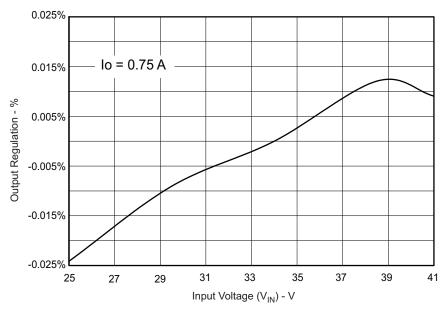


Figure 4. TPS54140EVM-429 Line Regulation

## 2.5 Load Transients

The TPS54140EVM-429 response to load transients is shown in Figure 5. The current step is from 0.25 A to 1.25 A. The input voltage is 34 V. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

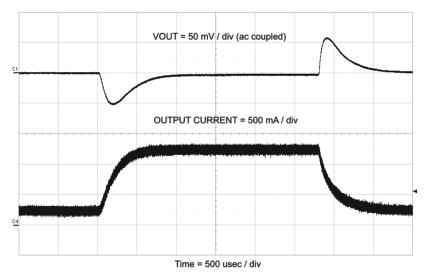


Figure 5. TPS54140EVM-429 Transient Response

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#### 2.6 **Loop Characteristics**

The TPS54140EVM-429 loop-response characteristics are shown in Figure 6. Gain and phase plots are shown for  $V_{IN}$  voltage of 34V. Load current for the measurement is 1.5  $\bar{A}$ .

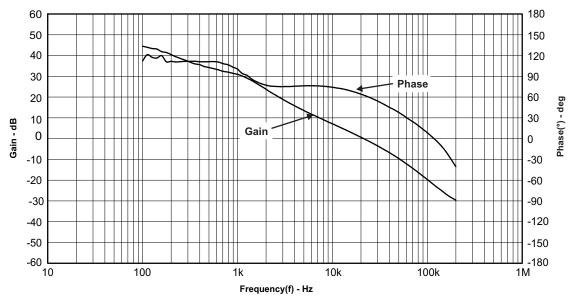


Figure 6. TPS54140EVM-429 Loop Response

#### 2.7 **Output Voltage Ripple**

The TPS54140EVM-429 output voltage ripple is shown in Figure 7. The output current is the rated full load of 1.5 A and  $V_{IN} = 34$  V. The ripple voltage is measured directly across the output capacitors.

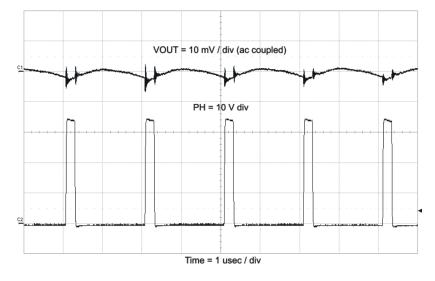


Figure 7. TPS54140EVM-429 Output Ripple

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# 2.8 Input Voltage Ripple

The TPS54140EVM-429 input voltage ripple is shown in Figure 8 . The output current is the rated full load of 1.5 A and  $V_{\text{IN}}$  = 34 V. The ripple voltage is measured directly across the input capacitors.

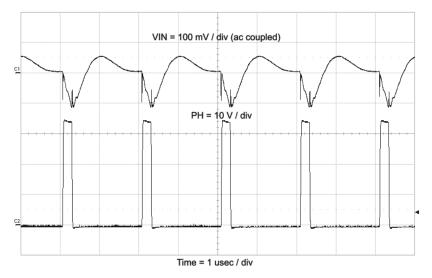


Figure 8. TPS54140EVM-429 Input Ripple

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# 2.9 Powering Up

The start-up waveforms are shown in Figure 9 . In Figure 9, the top trace shows  $V_{OUT}$ , and the bottom trace shows  $V_{IN}$ . The input voltage is initially applied, and when the input reaches the undervoltage lockout threshold, the start-up sequence begins and the output ramps up at the externally set rate toward the value of 3.3 V. the input voltage for this waveform is 34 V with a 1.5 A load.

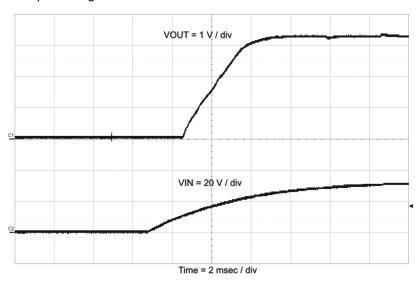


Figure 9. TPS54140EVM-429 Start-Up Relative to V<sub>IN</sub>

# 2.10 Eco-mode™ Operation

At light load currents, the TPS54140 is designed to operate in pulse skipping Eco-mode™. When the COMP pin lowers to 500 mV typical, the device enters Eco-mode™ operation.

Figure 10 shows Eco-mode operation, channel 1(C1) shows the output voltage while channel 2(C2) shows the switching node (PH).

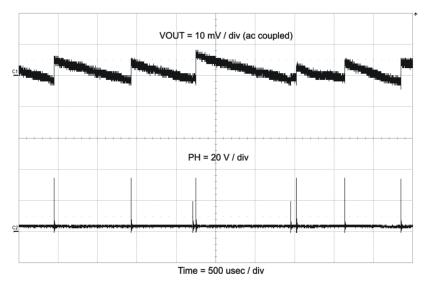


Figure 10. TPS54140EVM-429 Eco-mode™ Operation



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#### 3 **Board Layout**

This section provides a description of the TPS54140EVM-429, board layout, and layer illustrations.

#### 3.1 Layout

The board layout for the TPS54140EVM-429 is shown in Figure 11 through Figure 13. The topside layer of the EVM is laid out in a manner typical of a user application. The top and bottom layers are 2-oz. copper.

The top layer contains the main power traces for V<sub>IN</sub>, V<sub>OUT</sub>, and VPHASE. Also on the top layer are connections for the remaining pins of the TPS54140 and a large area filled with ground. The bottom layer contains ground and a signal route for the BOOT capacitor. The top and bottom and internal ground traces are connected with multiple vias placed around the board including ten vias directly under the TPS54140 device to provide a thermal path from the top-side ground plane to the bottom-side ground plane.

The input decoupling capacitors (C2, and C3) and bootstrap capacitor (C6) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper V<sub>OUT</sub> trace past the output capacitor (C5). For the TPS54140, an additional input bulk capacitor may be required (C!), depending on the EVM connection to the input supply.

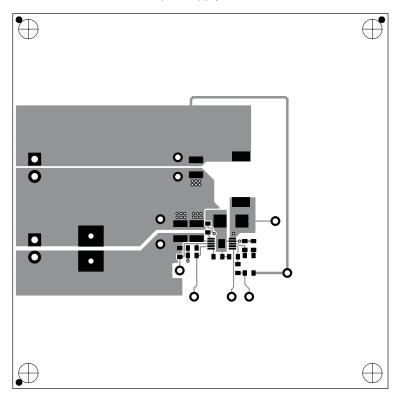


Figure 11. TPS54140EVM-429 Top-Side Layout

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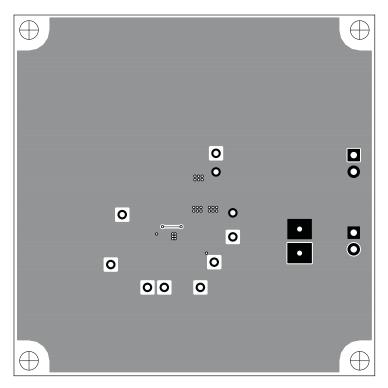


Figure 12. TPS54140EVM-429 Bottom-Side Layout

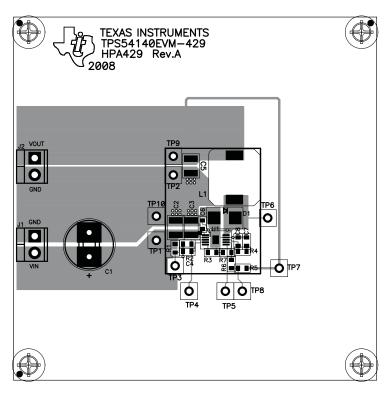


Figure 13. TPS54140EVM-429 Top-Side Assembly



# 3.2 Estimated Circuit Area

The estimated printed circuit board area for the components used in this design is 0.55 in<sup>2</sup>. This area does not include test point or connectors.

## 4 Schematic and Bill of Materials

This section presents the TPS54140EVM-429 schematic and bill of materials.



# 4.1 Schematic

Figure 14 is the schematic for the TPS54140EVM-429.

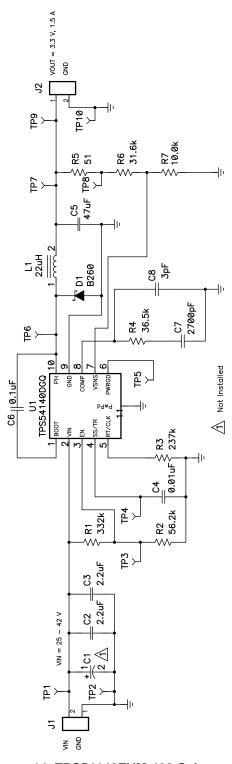


Figure 14. TPS54140EVM-429 Schematic



# 4.2 Bill of Materials

Table 5 presents the bill of materials for the TPS54140EVM-429.

# Table 5. TPS54140EVM-429 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
0	C1	Open	Capacitor, multi pattern, SM 1210 to E case + F THole	Multi sizes	Engineering Only	Std
2	C2, C3	2.2uF	2.2uF Capacitor, Ceramic, 100V, X7R, 10%	1210	Std	Std
1	C4	0.01uF	Capacitor, Ceramic, 25V, X5R, 20%	0603	Std	Std
1	C5	47uF	Capacitor, Ceramic, 10V, X5R, 20%	1210	Std	Std
1	C6	0.1uF	Capacitor, Ceramic, 25V, X5R, 10% "	0603	Std	Std
1	C7	2700pF	Capacitor, Ceramic, 10V, X5R, 10%	0603	Std	Std
1	C8	3pF	Capacitor, Ceramic, 50V, NPO, ±25pF	0603	Std	Std
1	D1	B260	Diode, Schottky, 2A, 60V	SMB	B260-13-F	Motorola
2	J1, J2	ED1514	Terminal Block, 2-pin, 6-A, 3.5mm	0.27" x 0.25"	ED1514	OST
1	L1	22uH	Inductor, SMT, 2.36A, 61milliohm	0.402 x 0.394 inch	MSS1048-223MLB	Coilcraft
1	R1	332k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R2	56.2k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R3	237k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R4	36.5k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R5	51	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R6	31.6k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R7	10.0k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
7	TP1, TP3, TP4, TP6, TP7 - TP9	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
3	TP2, TP5, TP10	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	U1	TPS54140D GQ	IC, DC-DC Converter, 3.3V, 1.5A	MSOP-10	TP54160DGQ	TI
1			PCB, 3.0" x 3.0		HPA429	Any

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#### **EVM WARNINGS AND RESTRICTIONS**

It is important to operate this EVM within the input voltage range and the output current range specified in Table 1.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 55°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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